

HCZ120N80M1

N-Channel eSiC Silicon Carbide Power MOSFET

1200 V, 30 A, 80 mΩ

Features

- High switching speed with a low gate charge
- Fast intrinsic diode with low reverse recovery
- Robust Avalanche Capability
- 100% Avalanche Tested
- Pb-free, Halogen Free, and RoHS Compliant

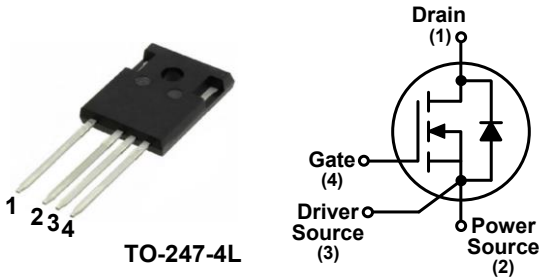
$BV_{DSS}, T_c=25^{\circ}C$	$I_D, T_c=25^{\circ}C$	$R_{DS(on),typ}$	$Q_{g,typ}$
1200 V	30 A	80 mΩ	52 nC

Benefits

- System efficiency improvement
- Higher frequency applicability
- Increased power density
- Reduced cooling effort

Applications

- Solar inverter
- EV charging station
- UPS
- Industrial power supply



Absolute Maximum Ratings ($T_C = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter		Value	Unit
V_{DSS}	Drain to Source Voltage		1200	V
V_{GS}	Gate to Source Voltage (DC)		-10 / +22	V
V_{GSop}	Recommended Operation Value		-5 / +18	V
I_D	Drain Current	Continuous ($T_C = 25^{\circ}C$)	30	A
		Continuous ($T_C = 100^{\circ}C$)	21	
I_{DM}	Drain Current	Pulsed (Note1)	80	A
P_D	Power Dissipation	($T_C = 25^{\circ}C$)	150	W
		Derate Above $25^{\circ}C$	1.00	W/ $^{\circ}C$
T_J, T_{STG}	Operating and Storage Temperature Range		-55 to 175	$^{\circ}C$
T_L	Maximum Lead Temperature for Soldering, 1/8" from Case for 10 Seconds		260	$^{\circ}C$

※Note 1 : Limited by maximum junction temperature.

Thermal Characteristics

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	1.00	$^{\circ}C/W$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	40	

Package Marking and Ordering Information

Part Number	Top Marking	Package	Packing Method	Quantity
HCZ120N80M1	HCZ120N80M1	TO-247-4L	Tube	30 units

Electrical Characteristics ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
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Off Characteristics

BV_{DSS}	Drain to Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_D = 1\text{ mA}$	1200			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 1200\text{ V}, V_{GS} = 0\text{ V}$		1	100	μA
		$V_{DS} = 1200\text{ V}, V_{GS} = 0\text{ V}, T_J = 175^\circ\text{C}$		5		
I_{GSS}	Gate-Source Leakage Current	$V_{GS} = +22\text{ V}, V_{DS} = 0\text{ V}$			+100	nA
		$V_{GS} = -10\text{ V}, V_{DS} = 0\text{ V}$			-100	

On Characteristics

$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 5.0\text{ mA}$ (tested after $V_{GS} = 22\text{ V}, 1\text{ ms pulse}$)	2.0	3.0	4.5	V
$R_{DS(on)}$	Static Drain to Source On Resistance	$V_{GS} = 18\text{ V}, I_D = 15\text{ A}$		80	110	m Ω
		$V_{GS} = 18\text{ V}, I_D = 15\text{ A}, T_J = 175^\circ\text{C}$		128		
g_{fs}	Transconductance	$V_{DS} = 20\text{ V}, I_D = 15\text{ A}$		11.4		S

Dynamic Characteristics

C_{iss}	Input Capacitance	$V_{DS} = 800\text{ V}, V_{GS} = 0\text{ V}, f = 250\text{ kHz}$		880		pF
C_{oss}	Output Capacitance			64		
C_{rss}	Reverse Capacitance			5		
E_{oss}	Stored Energy in Output Capacitance	$V_{DS} = 0\text{ V to } 800\text{ V}, V_{GS} = 0\text{ V}$		26		μJ
$C_{o(er)}$	Energy Related Output Capacitance			80		pF
$C_{o(tr)}$	Time Related Output Capacitance			142		
$Q_{g(tot)}$	Total Gate Charge	$V_{DS} = 800\text{ V}, I_D = 15\text{ A},$ $V_{GS} = -5\text{ V} / 18\text{ V},$ Inductive load		52		nC
Q_{gs}	Gate to Source Charge			13		
Q_{gd}	Gate to Drain "Miller" Charge			17		
R_G	Internal Gate Resistance	$f = 1\text{ MHz}$		4.0		Ω

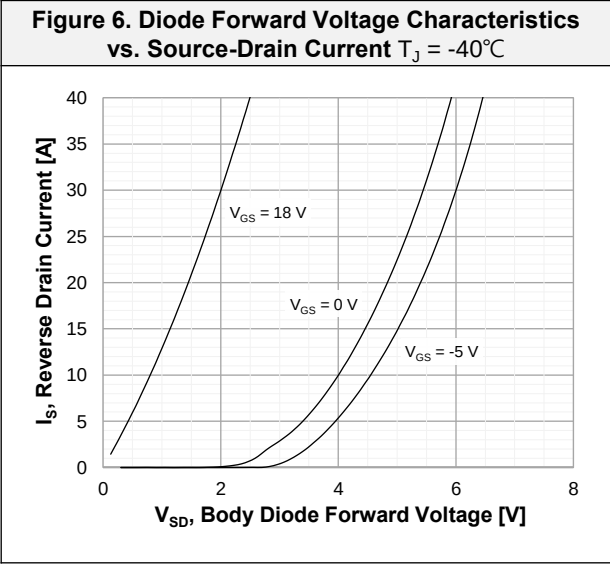
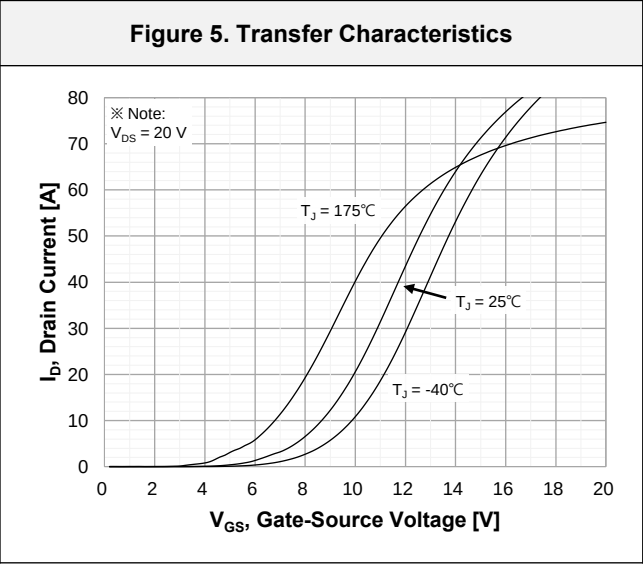
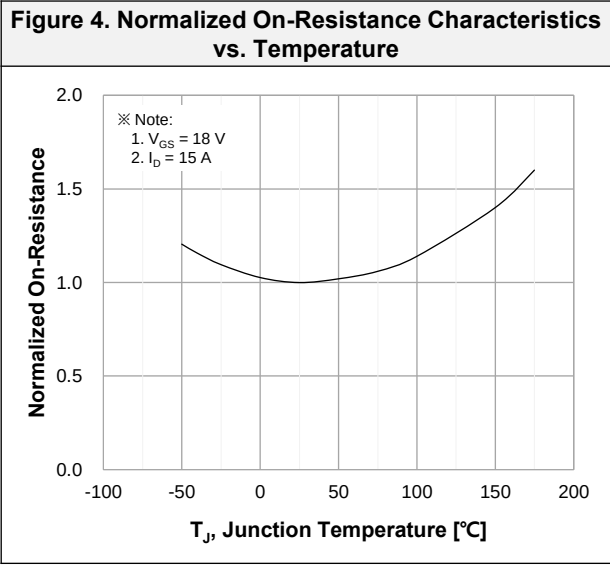
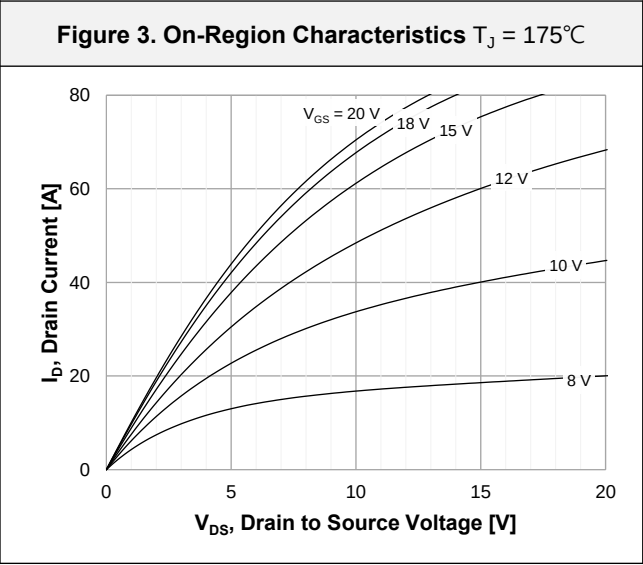
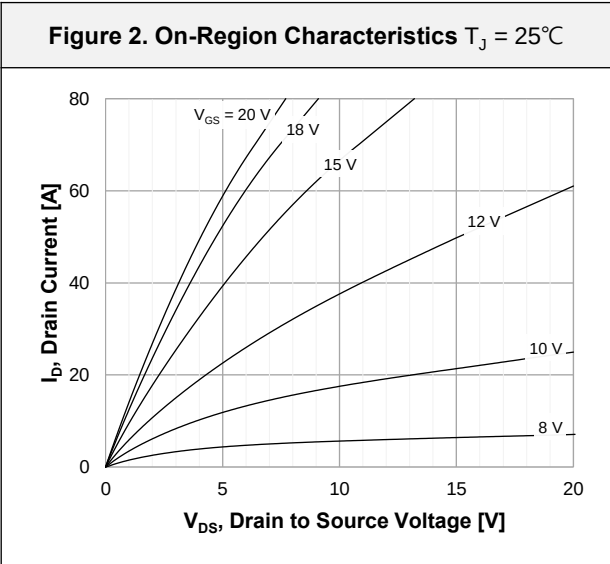
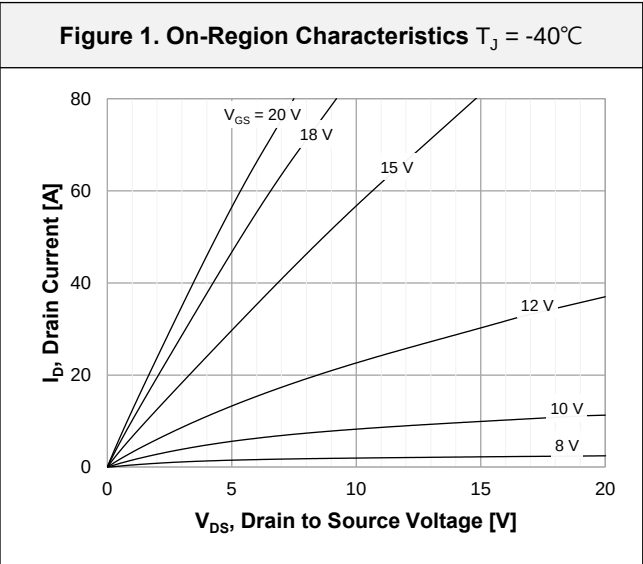
Switching Characteristics

$t_{d(on)}$	Turn-On Delay Time	$V_{DS} = 800\text{ V}, I_D = 15\text{ A},$ $V_{GS} = -5\text{ V} / 18\text{ V}, R_G = 2\text{ }\Omega,$ FWD : PCH120S10D1, Inductive load		14		ns
t_r	Turn-On Rise Time			9		
$t_{d(off)}$	Turn-Off Delay Time			24		
t_f	Turn-Off Fall Time			8		
E_{on}	Turn-on Switching Energy			75		μJ
E_{off}	Turn-off Switching Energy			47		
E_{tot}	Total Switching Energy			122		

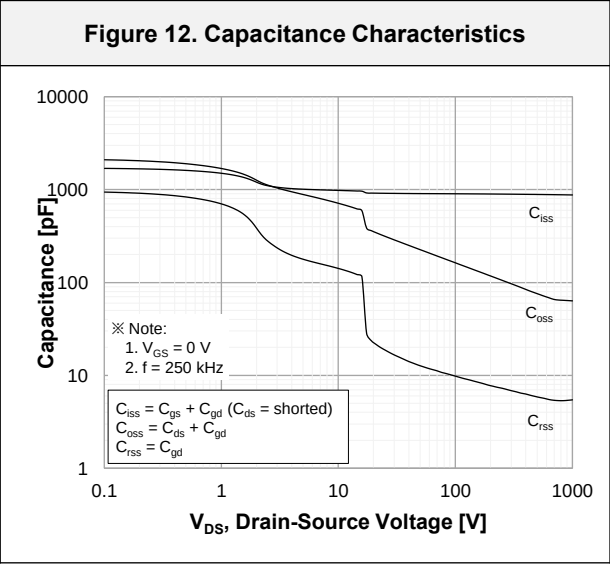
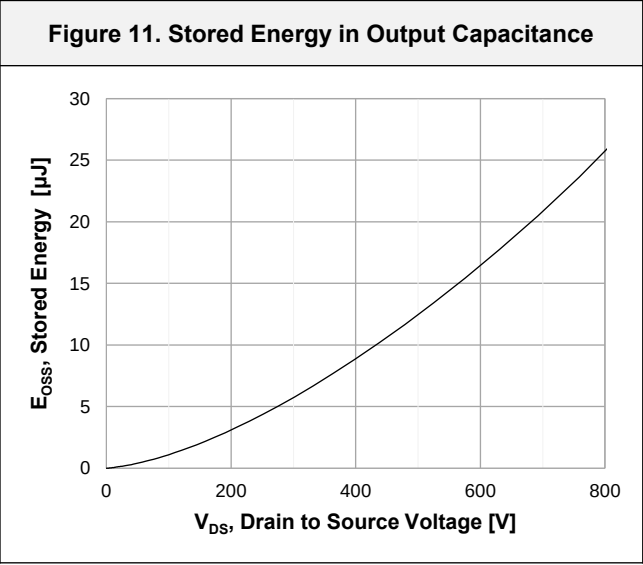
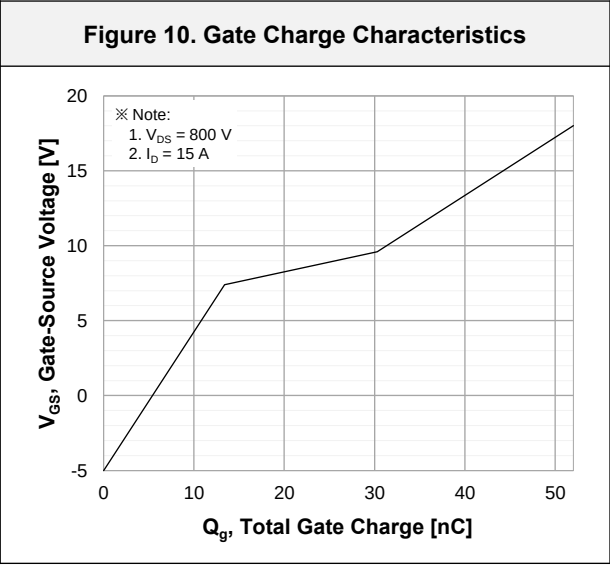
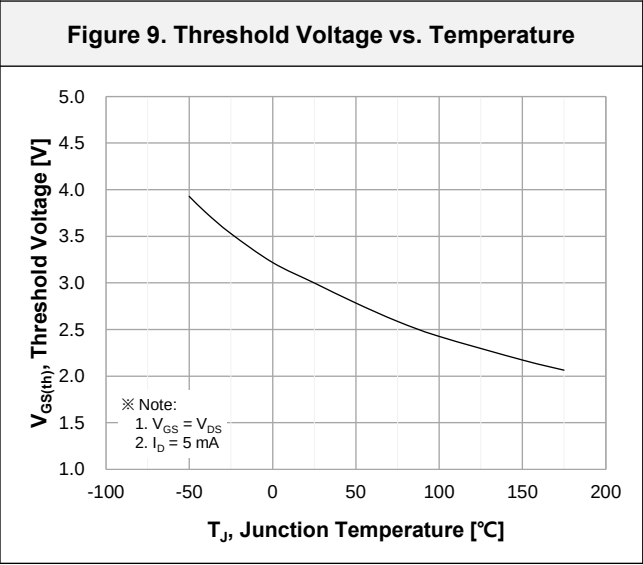
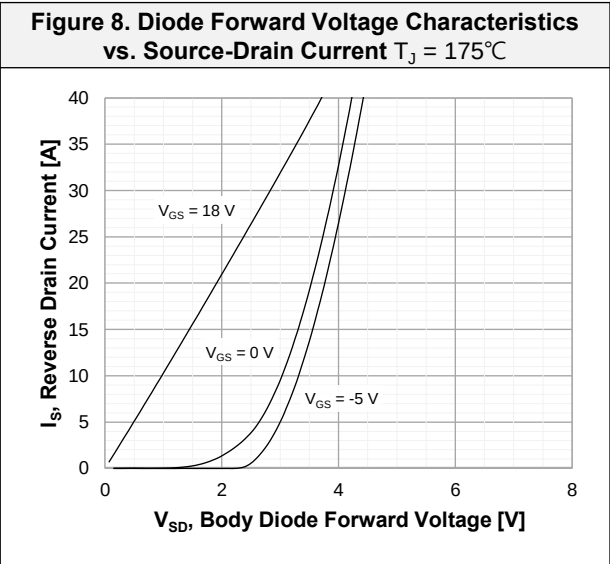
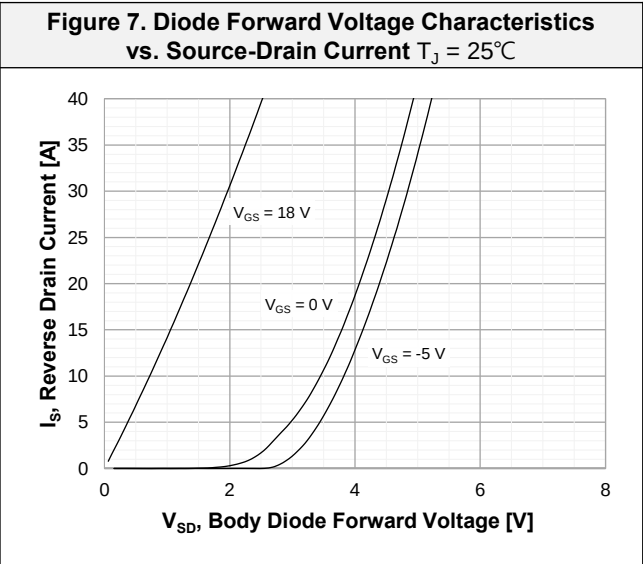
Source-Drain Diode Characteristics

I_S	Maximum Continuous Diode Forward Current			30	A
I_{SM}	Maximum Pulsed Diode Forward Current			80	
V_{SD}	Diode Forward Voltage	$V_{GS} = -5\text{ V}, I_{SD} = 15\text{ A}$		4.1	V
t_{rr}	Reverse Recovery Time	$V_{DD} = 800\text{ V}, I_{SD} = 15\text{ A},$ $di_F/dt = 3000\text{ A}/\mu\text{s}$, Includes Q_{oss}		12	ns
Q_{rr}	Reverse Recovery Charge			122	nC

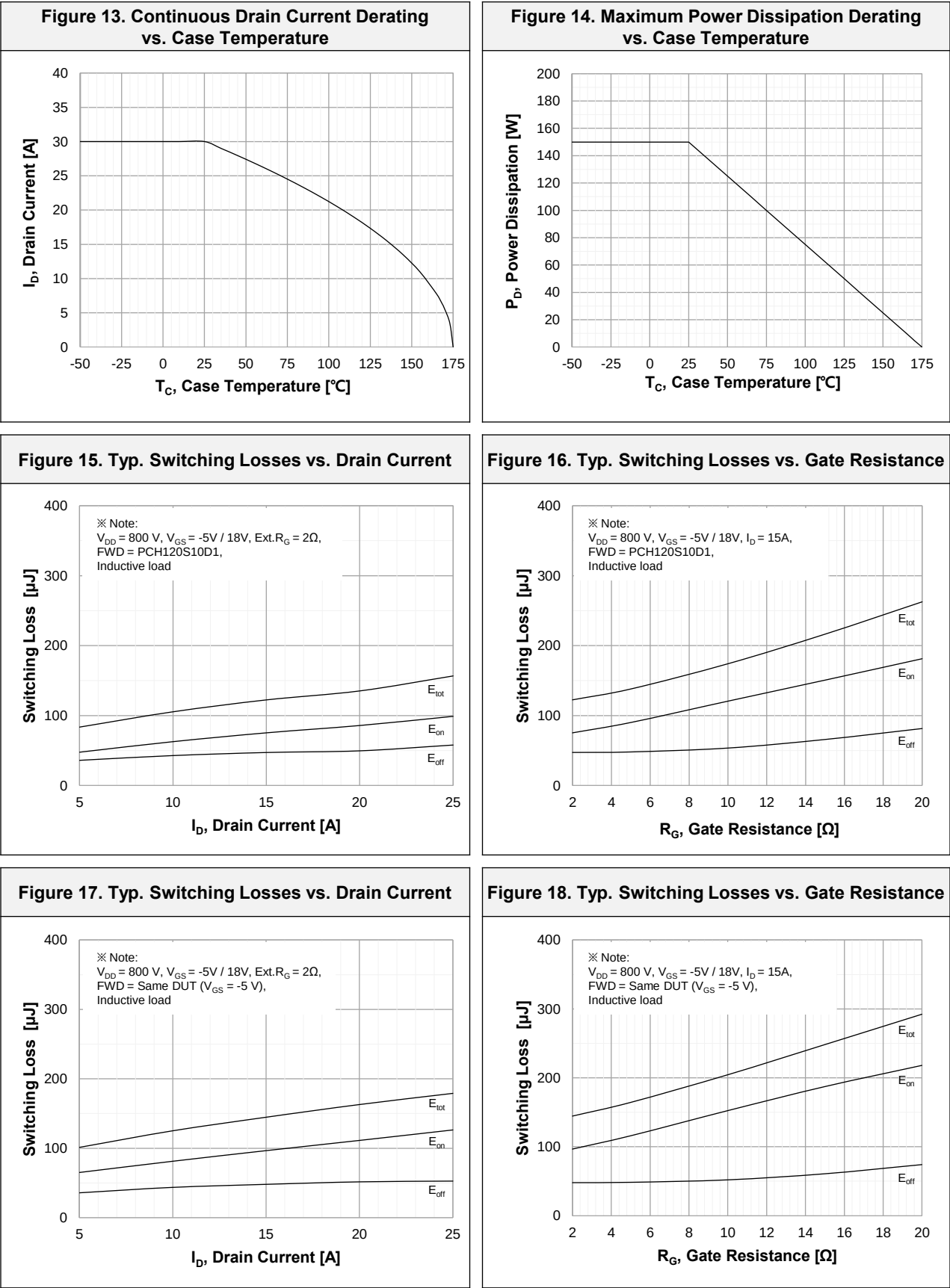
Typical Performance Characteristics



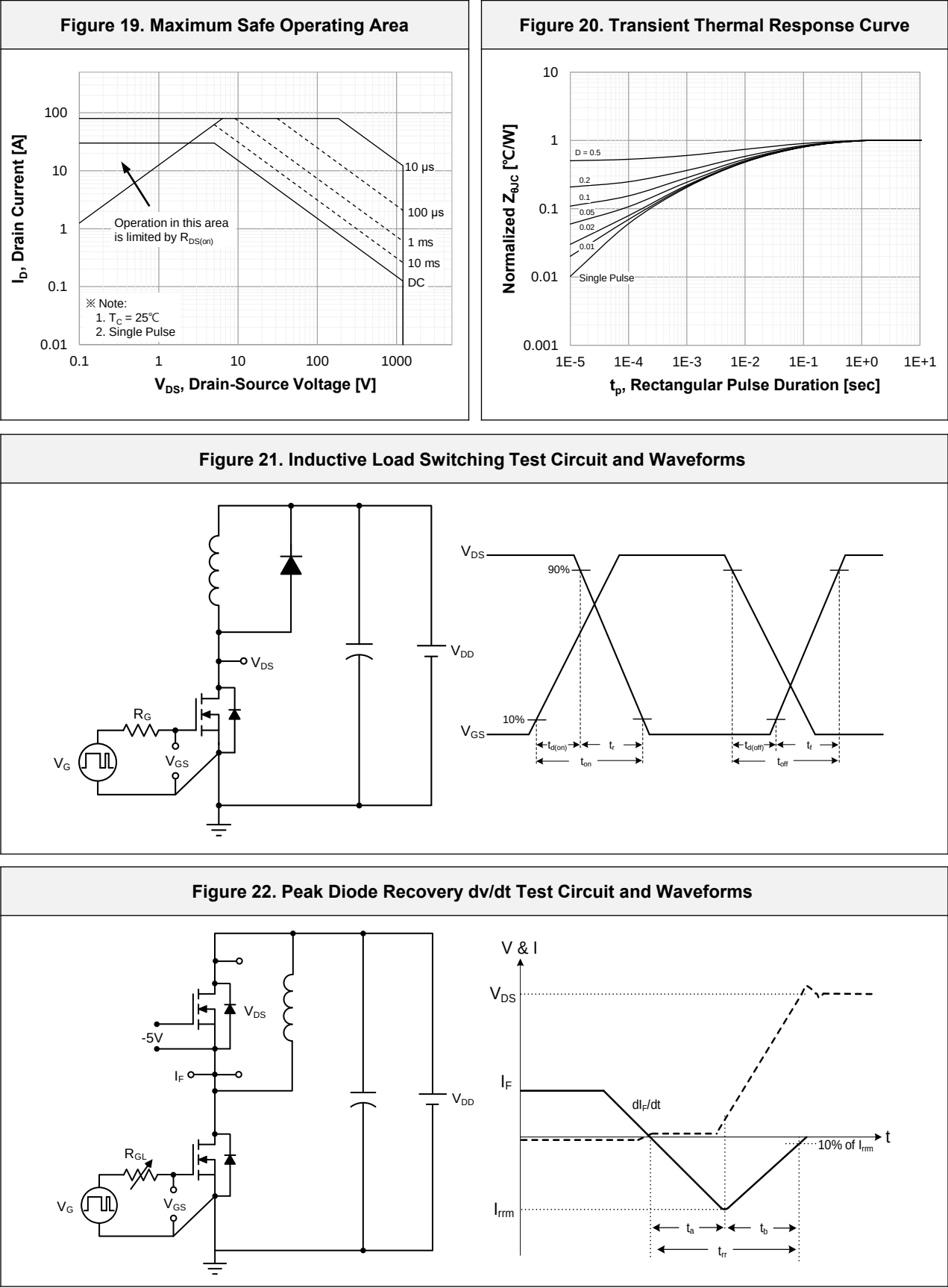
Typical Performance Characteristics



Typical Performance Characteristics

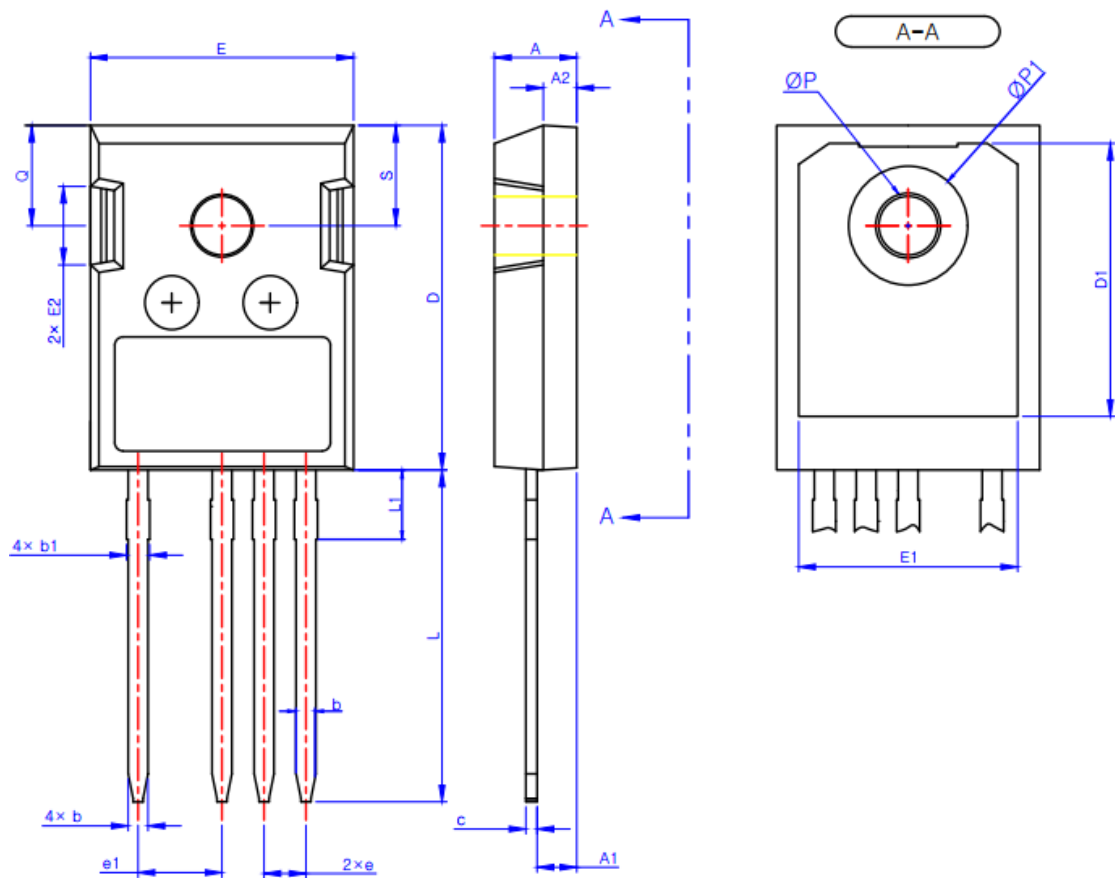


Typical Performance Characteristics



Package Outlines

TO-247-4L



SYMBOL	MIN	MAX
A	4.80	5.20
A1	2.29	2.54
A2	1.90	2.10
b	1.10	1.30
b1	1.30	1.50
c	0.50	0.70
D	20.80	21.10
D1	17.43	17.83
E	15.75	16.13
E1	13.06	13.46
E2	4.32	4.83
e	2.54 BSC	
e1	5.08 BSC	
L	19.85	20.25
L1	-	4.49
ØP	3.55	3.65
ØP1	7.00	7.40
Q	5.59	6.19
S	6.15 BSC	

* Dimensions in millimeters